



JFW  
Docket No. 5000-5118

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

*Fee Only*

Applicant(s) : Tomohei SUGIYAMA et al. Group Art Unit: 2891  
Serial No : 10/626,418 Examiner: D. Menz  
Filed : July 23, 2003  
For : METHOD OF MANUFACTURING A LOW EXPANSION MATERIAL  
AND SEMICONDUCTOR DEVICE USING THE LOW EXPANSION  
MATERIAL

**RESPONSE TO REQUIREMENT FOR RESTRICTION**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

In the May 4, 2005 Office Action, the Examiner issued a restriction requirement,  
requiring Applicants to elect one of four groups of claims:

- I. "Claim 1-8, drawn to a method of manufacturing a low expansion material, classified in class 75, subclass 330";
- II. "Claims 9-10, drawn to a semiconductor device, classified in class 257, subclass 741";
- III. "Claims 11-12, drawn to a semiconductor device with a semiconductor element mounted directly to a heat sink, classified in class 257, subclass 707"; or
- IV. "Claims 13-14, drawn to a semiconductor device with a heat releasing plate, classified in class 257, subclass 712."

Applicants provisionally elect Group III, claims 11-12.

Applicants furthermore respectfully traverse the Examiner's restriction requirement.